NSN 5962-01-232-5459

Memory Microcircuit - Page 1 of 2



View Online at https://aerobasegroup.com/nsn/5962-01-232-5459

view Online at https://aerobasegroup.com/hsi//3902-01-232-3439	
Body Length:	
1.285 inches	
Body Width:	
0.600 inches	
Body Height:	
0.217 inches	
Maximum Power Dissipation Rating:	
633.0 milliwatts	
Operating Tempurature Range:	
-55.0/+100.0 degrees celsius	
Storage Tempurature Range:	
-65.0/+125.0 degrees celsius	
Features Provided:	
Hermetically sealed and burn in and ultraviolet erasable and programmable and w/enable	
Inclosure Material:	
Ceramic	
Inclosure Configuration:	
Dual-in-line	
Output Logic Form:	
Metal oxide-semiconductor logic	
nput Circuit Pattern:	
13 input	
Terminal Surface Treatment:	
Solder	
Voltage Rating And Type Per Characteristic:	
6.0 volts power source	
Time Rating Per Chacteristic:	
450.00 nanoseconds propagation delay time, low to high level output and 450.00 nanoseconds propagation delay tir	me, high to low level
putput	
Memory Device Type:	
Rom	
Memory Capacity:	
Unknown	
Test Data Document:	
96906-mil-std-883 standard (includes industry or association standards, individual manufactureer standards, etc.).	
Terminal Type And Quantity:	
24 printed circuit	
Shelf Life:	
N/a	

- ---
- Demilitarization:
- Yes demil/mli

NSN 5962-01-232-5459

Memory Microcircuit - Page 2 of 2

Fiig: A458a0

